

To all our customers

---

## **Regarding the change of names mentioned in the document, such as Mitsubishi Electric and Mitsubishi XX, to Renesas Technology Corp.**

---

The semiconductor operations of Hitachi and Mitsubishi Electric were transferred to Renesas Technology Corporation on April 1st 2003. These operations include microcomputer, logic, analog and discrete devices, and memory chips other than DRAMs (flash memory, SRAMs etc.) Accordingly, although Mitsubishi Electric, Mitsubishi Electric Corporation, Mitsubishi Semiconductors, and other Mitsubishi brand names are mentioned in the document, these names have in fact all been changed to Renesas Technology Corp. Thank you for your understanding. Except for our corporate trademark, logo and corporate statement, no changes whatsoever have been made to the contents of the document, and these changes do not constitute any alteration to the contents of the document itself.

Note : Mitsubishi Electric will continue the business operations of high frequency & optical devices and power devices.

Renesas Technology Corp.  
Customer Support Dept.  
April 1, 2003

# FS30KMH-2

HIGH-SPEED SWITCHING USE

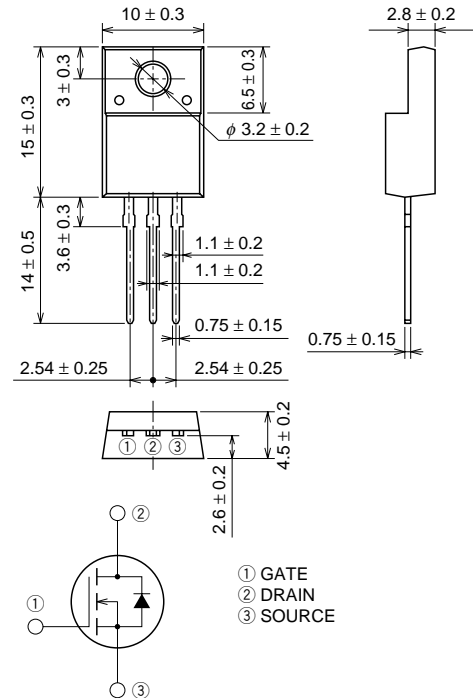
## FS30KMH-2



- 2.5V DRIVE
- V<sub>DSS</sub> ..... 100V
- r<sub>DS (ON)</sub> (MAX) ..... 93mΩ
- I<sub>D</sub> ..... 30A
- Integrated Fast Recovery Diode (TYP.) ..... 95ns
- V<sub>iso</sub> ..... 2000V

## OUTLINE DRAWING

Dimensions in mm



TO-220FN

## APPLICATION

Motor control, Lamp control, Solenoid control  
DC-DC converter, etc.

## MAXIMUM RATINGS (T<sub>c</sub> = 25°C)

Symbol	Parameter	Conditions	Ratings	Unit
V <sub>DSS</sub>	Drain-source voltage	V <sub>GS</sub> = 0V	100	V
V <sub>GSS</sub>	Gate-source voltage	V <sub>DS</sub> = 0V	±10	V
I <sub>D</sub>	Drain current		30	A
I <sub>DM</sub>	Drain current (Pulsed)		120	A
I <sub>DA</sub>	Avalanche drain current (Pulsed)	L = 100μH	30	A
I <sub>S</sub>	Source current		30	A
I <sub>SM</sub>	Source current (Pulsed)		120	A
P <sub>D</sub>	Maximum power dissipation		25	W
T <sub>ch</sub>	Channel temperature		-55 ~ +150	°C
T <sub>stg</sub>	Storage temperature		-55 ~ +150	°C
V <sub>iso</sub>	Isolation voltage	AC for 1minute, Terminal to case	2000	V
—	Weight	Typical value	2.0	g

# FS30KMH-2

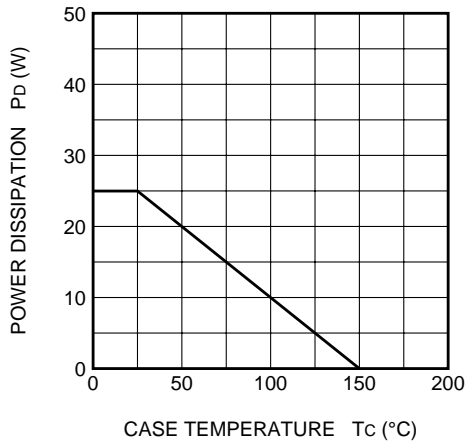
HIGH-SPEED SWITCHING USE

## ELECTRICAL CHARACTERISTICS (T<sub>ch</sub> = 25°C)

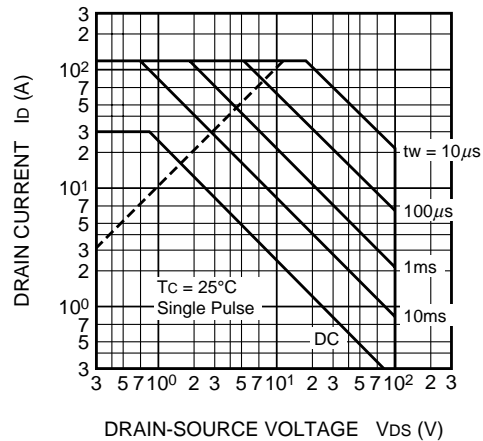
Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
V (BR) DSS	Drain-source breakdown voltage	I <sub>D</sub> = 1mA, V <sub>GS</sub> = 0V	100	—	—	V
I <sub>GSS</sub>	Gate-source leakage current	V <sub>GS</sub> = ±10V, V <sub>DS</sub> = 0V	—	—	±0.1	μA
I <sub>DSS</sub>	Drain-source leakage current	V <sub>DS</sub> = 100V, V <sub>GS</sub> = 0V	—	—	0.1	mA
V <sub>GS</sub> (th)	Gate-source threshold voltage	I <sub>D</sub> = 1mA, V <sub>DS</sub> = 10V	0.6	0.9	1.2	V
r <sub>DS</sub> (ON)	Drain-source on-state resistance	I <sub>D</sub> = 15A, V <sub>GS</sub> = 4V	—	66	93	mΩ
r <sub>DS</sub> (ON)	Drain-source on-state resistance	I <sub>D</sub> = 15A, V <sub>GS</sub> = 2.5V	—	69	97	mΩ
V <sub>DS</sub> (ON)	Drain-source on-state voltage	I <sub>D</sub> = 15A, V <sub>GS</sub> = 4V	—	0.99	1.40	V
y <sub>fs</sub>	Forward transfer admittance	I <sub>D</sub> = 15A, V <sub>DS</sub> = 10V	—	31	—	S
C <sub>iss</sub>	Input capacitance	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V, f = 1MHz	—	2000	—	pF
C <sub>oss</sub>	Output capacitance		—	230	—	pF
C <sub>rss</sub>	Reverse transfer capacitance		—	120	—	pF
t <sub>d</sub> (on)	Turn-on delay time	V <sub>DD</sub> = 50V, I <sub>D</sub> = 15A, V <sub>GS</sub> = 4V, R <sub>GEN</sub> = R <sub>GS</sub> = 50Ω	—	33	—	ns
t <sub>r</sub>	Rise time		—	135	—	ns
t <sub>d</sub> (off)	Turn-off delay time		—	170	—	ns
t <sub>f</sub>	Fall time		—	170	—	ns
V <sub>SD</sub>	Source-drain voltage	I <sub>S</sub> = 15A, V <sub>GS</sub> = 0V	—	1.0	1.5	V
R <sub>th</sub> (ch-c)	Thermal resistance	Channel to case	—	—	5.00	°C/W
t <sub>rr</sub>	Reverse recovery time	I <sub>S</sub> = 30A, di <sub>s</sub> /dt = -100A/μs	—	95	—	ns

## PERFORMANCE CURVES

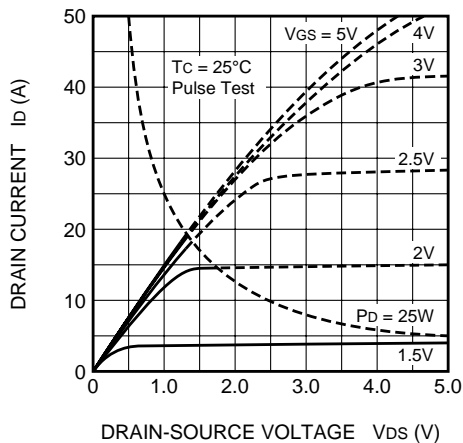
POWER DISSIPATION DERATING CURVE



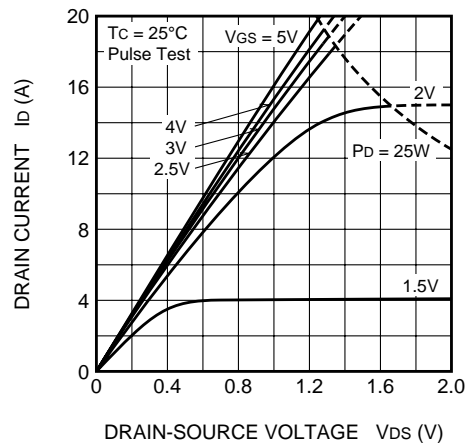
MAXIMUM SAFE OPERATING AREA



OUTPUT CHARACTERISTICS (TYPICAL)



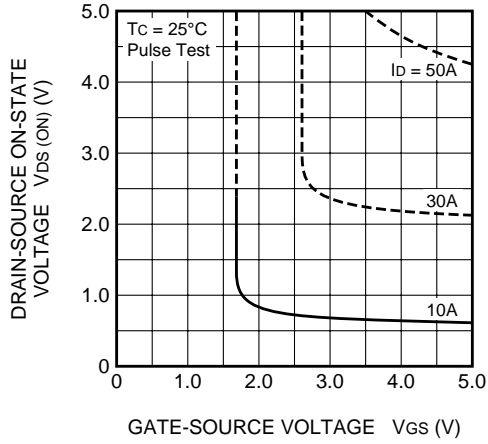
OUTPUT CHARACTERISTICS (TYPICAL)



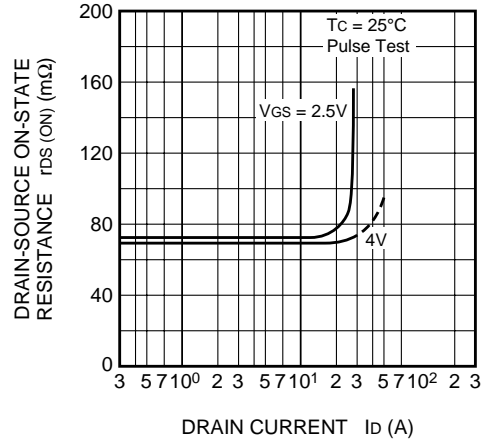
# FS30KMH-2

HIGH-SPEED SWITCHING USE

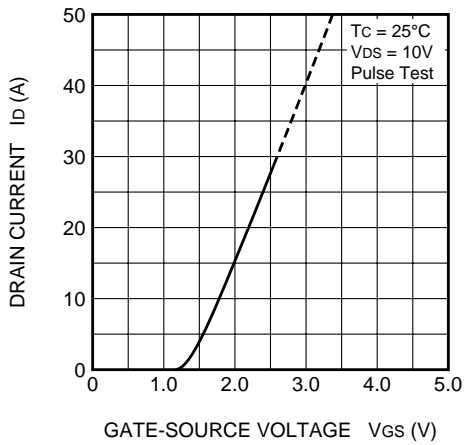
**ON-STATE VOLTAGE VS. GATE-SOURCE VOLTAGE (TYPICAL)**



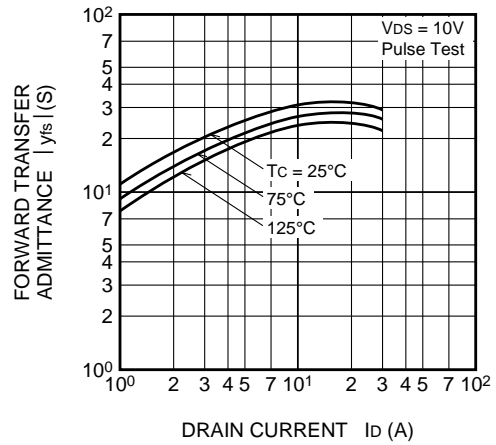
**ON-STATE RESISTANCE VS. DRAIN CURRENT (TYPICAL)**



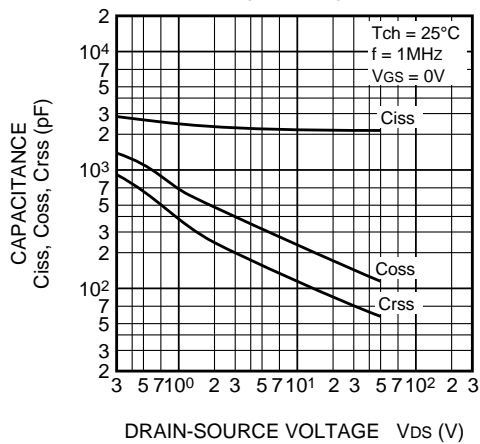
**TRANSFER CHARACTERISTICS (TYPICAL)**



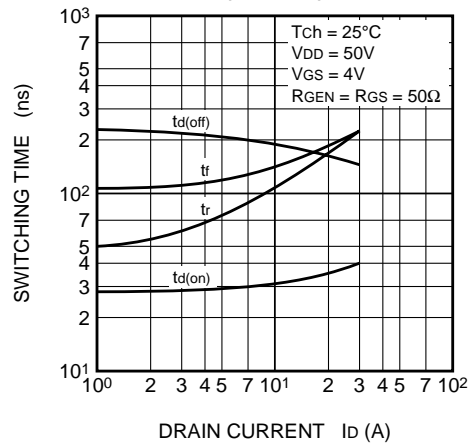
**FORWARD TRANSFER ADMITTANCE VS. DRAIN CURRENT (TYPICAL)**



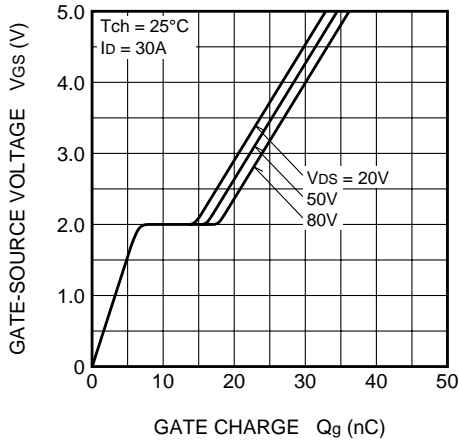
**CAPACITANCE VS. DRAIN-SOURCE VOLTAGE (TYPICAL)**



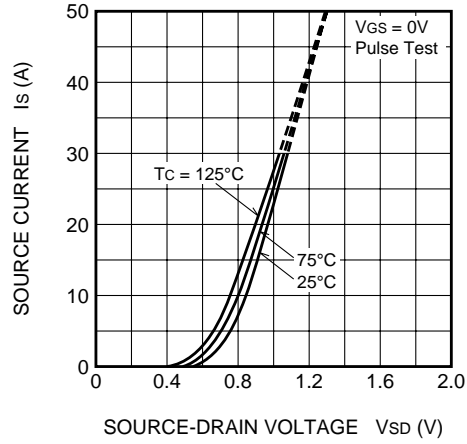
**SWITCHING CHARACTERISTICS (TYPICAL)**



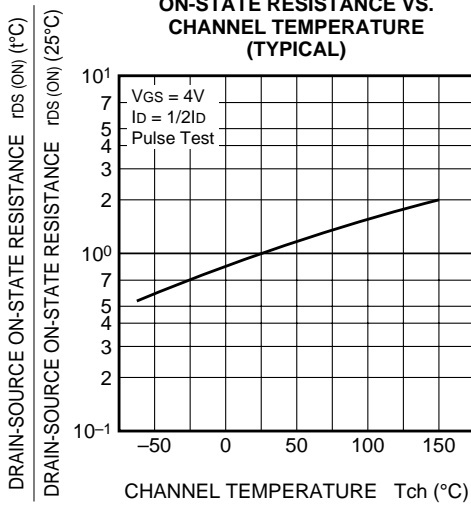
**GATE-SOURCE VOLTAGE VS. GATE CHARGE (TYPICAL)**



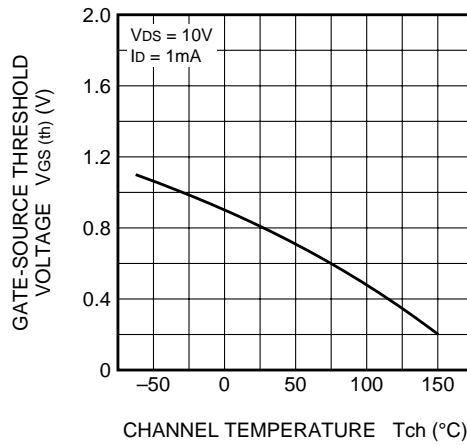
**SOURCE-DRAIN DIODE FORWARD CHARACTERISTICS (TYPICAL)**



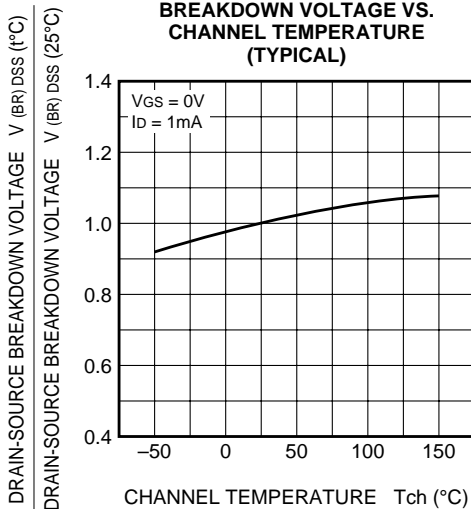
**ON-STATE RESISTANCE VS. CHANNEL TEMPERATURE (TYPICAL)**



**THRESHOLD VOLTAGE VS. CHANNEL TEMPERATURE (TYPICAL)**



**BREAKDOWN VOLTAGE VS. CHANNEL TEMPERATURE (TYPICAL)**



**TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS**

